## **Tyrone Camarero Specifications**

## Camarero DS200T6T-212RF

Key Features:

## Four hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:

- Dual socket R (LGA 2011) supports Intel® Xeon® processor E5-2600 .
- and E5-2600 v2 family Up to 512GB ECC DDR3, up to 1866MHz; 8x DIMM sockets .
- . 1x PCI-E 3.0 (x16) low-profile slot
- Intel<sup>®</sup> i350 Dual port Gigabit Ethernet .
- 3x 3.5" Hot-swap SATA3/SATA2HDD Bays .
- 1620W Redundant Power Supplies 80 PLUS, Platinum Level (94%+)







Processor/Cache		Front Panel :	
Processor	Dual socket R (LGA 2011) supports Intel® Xeon® processor E5-2600 and E5-2600 v2 family	LED Indicators Buttons	Power LED /Hard drive activity LED /2x Network activity LEDs /System Overheat LED Power On/Off button, System Reset button UID button
Chipset		Drive bays	
Intel® C602 Chipset		HDD bays Peripheral Bays	3x 3.5" Hot-swap SATA3/SATA2HDD Bays None
System Memory		Power Supply	
Memory Capacit	8x 240-pin DDR3 DIMM sockets Up to 512GB DDR3 ECC LRDIMM Up to 256GB DDR3 ECC Registered memory (RDIMM)	1620W Redundant Power Supplies 80 PLUS, Platinum Level (94%)	
Expansion Slots		Cooling System	
PCI-Express	1x PCI-E 3.0 (x16) Low-profile slot	4x 8cm heavy duty PWM fans with optimal fan speed control	
Integrated On-Board		Form Factor	
SATA LAN RJ45 Dedicated	SATA 2.0 & 3.0 with RAID 0, 1, 5, 10 2x RJ45 Gigabit Ethernet LAN ports 1x IPMI LAN port	2U Rackmount, Width – 17.25" (438mm), Height - 3.47" (88mm), Depth - 26.75" (679mm)	
Add-on Optio	ns		
RAID Card Optical Drive	Optional		nfo@tyronesystems.com urrent product information, visit

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